

1 Characteristics

Table 1. Absolute ratings (T_{amb} = 25 °C)

Symbol		Value	Unit	
V _{pp}	Peak pulse voltage	IEC 61000-4-5 contact discharge	30	kV
I _{pp}	Peak pulse current	8/20µs	15	Α
T _{stg}	Storage junction temperature	-55 to +150	°C	
Tj	Operating junction temperature	-40 to +125		
TL	Maximum temperature for solo	260	°C	

Table 2. Electrical characteristics (T_{amb} = 25 °C)

Order code	I _{RM} at V _{RM}		V _{BR} at I _{BR}		V _{CL} AT I _{PP} 8/20 μs		C ⁽¹⁾		ΔC ⁽²⁾
Order code	Мах. µА	V	Min. V	mA	Max. V	Α	Тур. рF	Max. pF	Typ. pF
DSL04-005SC6	0.2	5	6.5	1	20	15	1	3	0.3
DSL04-008SC6	0.2	8	10	1	25	15	1	3	0.3
DSL04-010SC6	0.2	10	11	1	27	15	1	3	0.3
DSL04-012SC6	0.2	12	14	1	31	15	1	3	0.3
DSL04-016SC6	0.2	16	20	1	37	15	1	3	0.3
DSL04-018SC6	0.2	18	21	1	39	15	1	3	0.3
DSL04-020SC6	0.2	20	23	1	42	15	1	3	0.3
DSL04-022SC6	0.2	22	25	1	45	15	1	3	0.3
DSL04-024SC6	0.2	24	27	1	52	15	1	3	0.3

^{1.} Test conditions: $V_R = 2 V \text{ bias}$, $V_{RMS} = 1 V$, f = 1 MHz

^{2.} Measured between 1 V and V_{RM}



1.1 Characteristics (curves)

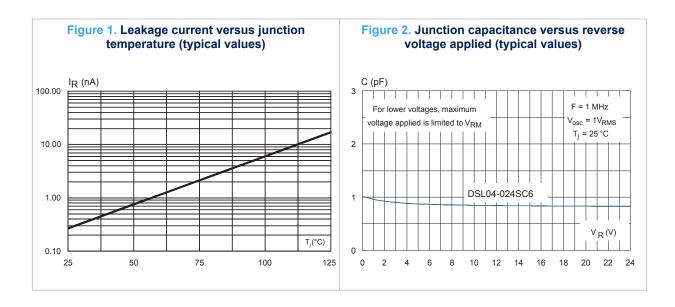
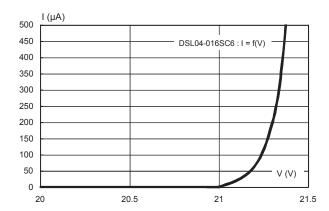


Figure 3. I / V characteristics (typical values)



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Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SOT23-6L package information

- Epoxy meets UL 94,V0
- · Lead-free package

Figure 4. SOT23-6L package outline

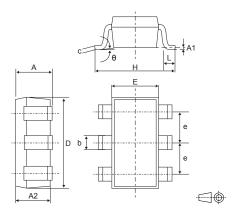


Table 3. SOT23-6L package mechanical data

	Dimensions							
Ref.	Millimeters			Inches				
	Min.	Тур.	Max.	Min.	Тур.	Max.		
А	0.9		1.45	0.0354		0.0571		
A1	0		0.15	0		0.0059		
A2	0.9		1.3	0.0354		0.0512		
b	0.30		0.5	0.0118		0.0197		
С	0.09		0.2	0.0035		0.0079		
D	2.8		3.05	0.1102		0.1201		
E	1.5		1.75	0.0591		0.0689		
е		0.95			0.0374			
Н	2.6		3	0.1024		0.1181		
L	0.3		0.6	0.0118		0.0236		
θ	0		10	0		0.3937		

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Figure 5. Footprint recommendations, dimensions in mm (inches)

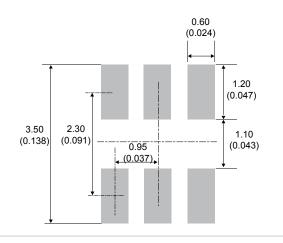


Figure 6. Marking layout (refer to ordering information table for marking)

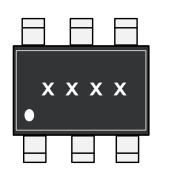
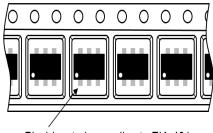


Figure 7. Package orientation in reel



Pin 1 located according to EIA-481

Note: Pocket dimensions are not on scale

Pocket shape may vary depending on package



Figure 9. Reel dimensions (mm)

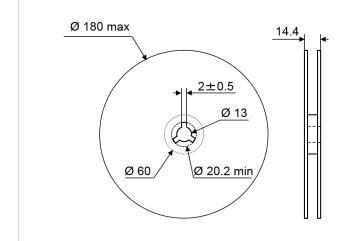
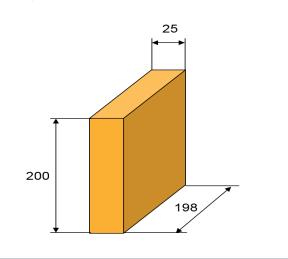


Figure 10. Inner box dimensions (mm)



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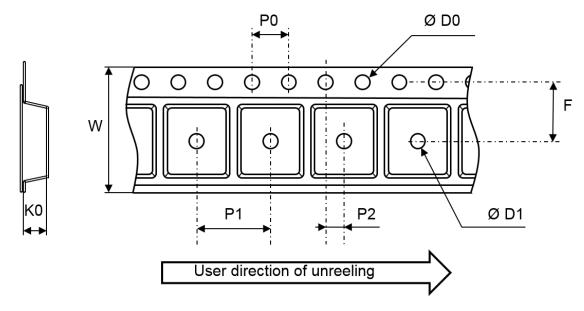


Figure 11. Tape and reel outline

Note: Pocket dimensions are not on scale Pocket shape may vary depending on package

Table 4. Tape and reel mechanical data

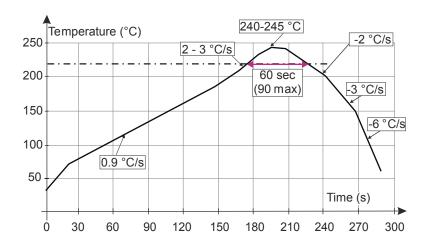
	Dimensions						
Ref.	Millimeters						
	Min.	Тур.	Max.				
P1	3.9	4	4.1				
P0	3.9	4	4.1				
D0	1.45	1.5	1.6				
D1	1						
F	3.45	3.5	3.55				
K0	1.3	1.4	1.6				
P2	1.95	2	2.05				
W	7.9	8	8.3				

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2.2 Reflow profile

Figure 12. ST ECOPACK recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

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3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
DSL04-005SC6	DT05				
DSL04-008SC6	DT08				
DSL04-010SC6	DT10				
DSL04-012SC6	DT12	SOT23-6L		3000	Tape and reel
DSL04-016SC6	DT16		14 mg		
DSL04-018SC6	DT18				
DSL04-020SC6	DT20				
DSL04-022SC6	DT22				
DSL04-024SC6	DT24				



Revision history

Table 6. Document revision history

Date	Revision	Changes
24-Feb-2012	1	Initial release.
03-Feb-2015	2	Reformatted to current standard.
		Updated Section DSL04 schematics, Section Features and Section Complies with the following standards.
25-Nov-2019	3	Added Figure 12. ST ECOPACK recommended soldering reflow profile for PCB mounting.
		Removed fig. 8 Ordering information scheme.



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